

ELW



PATENT  
8026-1004

IN THE U.S. PATENT AND TRADEMARK OFFICE

In re application of

Koki HIRASAWA et al.

Conf. 2347

Application No. 09/923,394

Group 2826

Filed August 8, 2001

Examiner F. Erdem

LEAD FRAME, SEMICONDUCTOR DEVICE  
PRODUCED BY USING THE SAME AND METHOD  
OF PRODUCING THE SEMICONDUCTOR DEVICE

**SUPPLEMENAL INFORMATION DISCLOSURE STATEMENT**

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

In compliance with Rules 1.97 and 1.98, and in fulfillment of the duty of disclosure under Rule 1.56, the accompanying document, a copy of which is attached to this statement, is made of record on the enclosed Form PTO-1449.

A concise explanation of the relevance of this item is that this reference was cited by the Korean Patent Office in an Official Action. A copy of the Korean Official Action and Japanese translation in which it was cited is attached hereto. **An English translation is also attached hereto.**

Under the provisions of 37 CFR 1.97(e), the undersigned hereby certifies that each item of information contained in this Supplemental Information Disclosure Statement was first cited in any communication from a foreign Patent Of-

fice in a counterpart foreign application not more than three months prior to the filing of this Statement.

Respectfully submitted,

YOUNG & THOMPSON



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